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# Onsemi

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# MOSFET – Power, N-Channel, SUPERFET<sup>®</sup> III, FAST

# 650 V, 67 mΩ, 40 A

# NTHL067N65S3H

# Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provides superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET FAST series helps minimize various power systems and improve system efficiency.

## Features

- 700 V @ T<sub>J</sub> = 150°C
- Typ.  $R_{DS(on)} = 55 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 80 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 691 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

## Applications

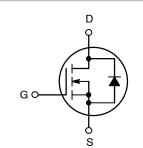
- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar

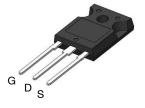


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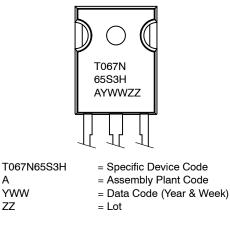
V <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
650 V	$67~\mathrm{m}\Omega$ @ 10 V	40 A





TO-247 Long Leads CASE 340CX

# MARKING DIAGRAM



## **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		650	V
V <sub>GSS</sub>	Gate to Source Voltage	– DC	±30	V
		– AC (f > 1 Hz)	±30	
ID	Drain Current	– Continuous (T <sub>C</sub> = 25°C)	40	А
		– Continuous (T <sub>C</sub> = 100°C)	25	
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	112	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		422	mJ
I <sub>AS</sub>	Avalanche Current (Note 2)		6.5	А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		2.66	mJ
dv/dt	MOSFET dv/dt		120	V/ns
	Peak Diode Recovery dv/dt (Note 3)	20		
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)	266	W
		– Derate Above 25°C	2.13	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		260	°C

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 6.5 \text{ A}, R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ . 3.  $I_{SD} \le 20 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{ V}_{DD} \le 400 \text{ V}$ , starting  $T_J = 25^{\circ}\text{C}$ .

### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.47	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

#### PACKAGE MARKING AND ORDERING INFORMATION

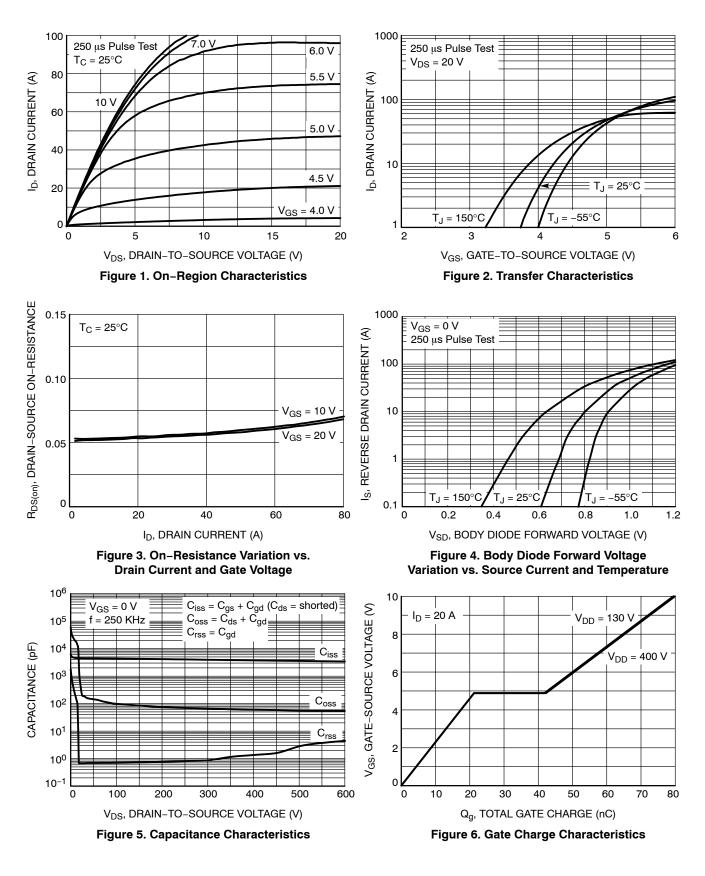
Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NTHL067N65S3H	T067N65S3H	TO-247	Tube	N/A	N/A	30 Units

# ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

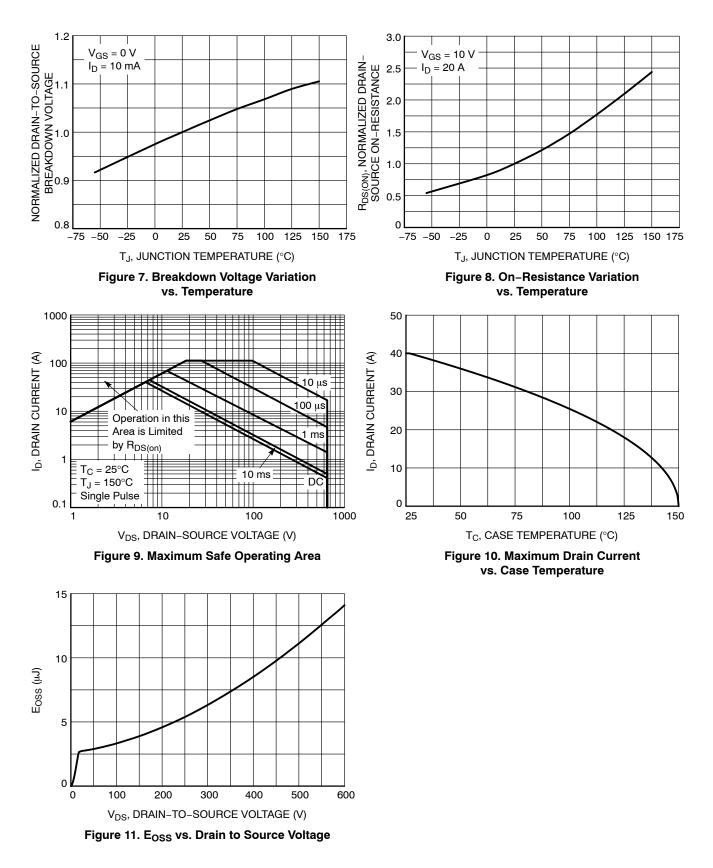
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 25°C	650	-	-	V
		$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 150°C	700	-	-	V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 10 mA, Referenced to 25°C	_	0.63	_	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ = 650 V, $V_{GS}$ = 0 V	-	-	2	μA
		$V_{DS}$ = 520 V, $T_C$ = 125 °C	-	1.6	-	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V	-	-	±100	nA
ON CHARACTE	RISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 3.9$ mA	2.4	-	4.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 20 A	-	55	67	mΩ
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	28	-	S
DYNAMIC CHA	RACTERISTICS					
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 250 kHz	-	3750	-	pF
C <sub>oss</sub>	Output Capacitance		-	60	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	_	691	-	pF
Coss(er.)	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	_	107	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	80	-	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	(Note 4)	_	21	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	20	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.6	-	Ω
SWITCHING CH	IARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 20 \text{ A},$	-	29	-	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ (Note 4)	-	8.5	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	80	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	2.6	-	ns
SOURCE-DRAI	N DIODE CHARACTERISTICS					
ا <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current			-	40	Α
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current		-	-	112	А
$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS}$ = 0 V, $I_{SD}$ = 20 A	_	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{DD} = 400 \text{ V}, \text{ I}_{SD} = 20 \text{ A},$	_	403	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dl <sub>F</sub> /dt = 100 A/μs	_	7.4	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

#### TYPICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)



# **TYPICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)



**TYPICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

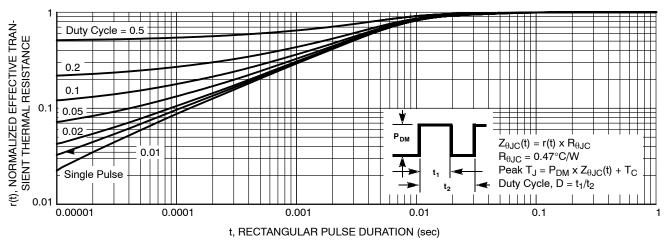


Figure 12. Transient Thermal Impedance

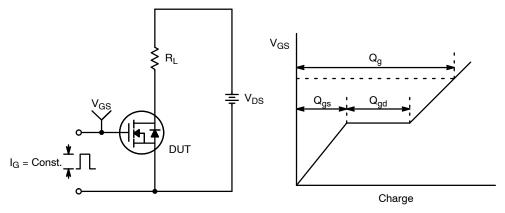


Figure 13. Gate Charge Test Circuit & Waveform

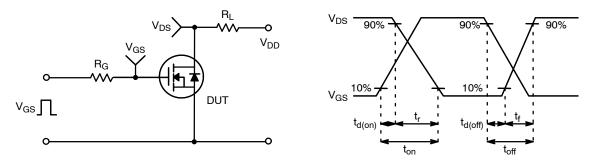


Figure 14. Resistive Switching Test Circuit & Waveforms

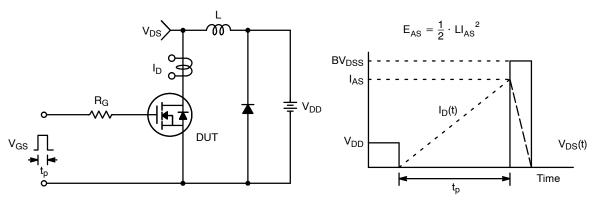


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

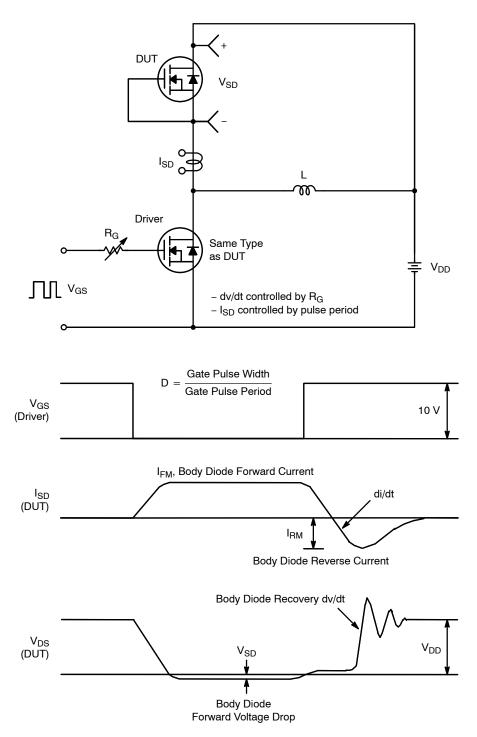
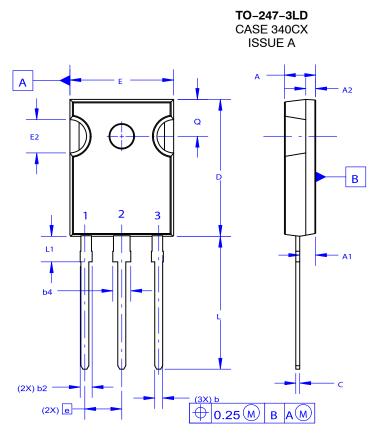


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

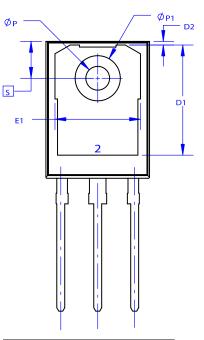
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## PACKAGE DIMENSIONS



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.



DIM	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	4.58	4.70	4.82	
A1	2.20	2.40	2.60	
A2	1.40	1.50	1.60	
D	20.32	20.57	20.82	
E	15.37	15.62	15.87	
E2	4.96	5.08	5.20	
е	~	5.56	~	
L	19.75	20.00	20.25	
L1	3.69	3.81	3.93	
ØР	3.51	3.58	3.65	
Q	5.34	5.46	5.58	
S	5.34	5.46	5.58	
b	1.17	1.26	1.35	
b2	1.53	1.65	1.77	
b4	2.42	2.54	2.66	
с	0.51	0.61	0.71	
D1	13.08	~	~	
D2	0.51	0.93	1.35	
E1	12.81	~	~	
Ø <b>P</b> 1	6.60	6.80	7.00	

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